

October 2000

# FDFS2P102

# Integrated P-Channel MOSFET and Schottky Diode

## **General Description**

The FDFS2P102 combines the exceptional performance of Fairchild's high cell density MOSFET with a very low forward voltage drop Schottky barrier rectifier in an SO-8 package.

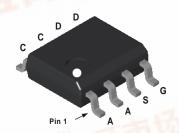
This device is designed specifically as a single package solution for DC to DC converters. It features a fast switching, low gate charge MOSFET with very low on-state resistance. The independently connected Schottky diode allows its use in a variety of DC/DC converter topologies.

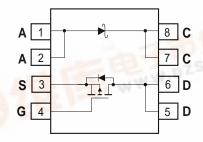
## **Applications**

- DC/DC converters
- Load Switch
- Motor Drives

### **Features**

- -3.3 A, -20 V.  $R_{DS(ON)} = 0.125~\Omega @ V_{GS} = -10~V$   $R_{DS(ON)} = 0.200~\Omega @ V_{GS} = -4.5~V.$
- $V_F < 0.39 V @ 1 A (T_J = 125 {}^{0}C)$ .  $V_F < 0.47 V @ 1 A$ .  $V_F < 0.58 V @ 2 A$ .
- Schottky and MOSFET incorporated into single power surface mount SO-8 package.
- Electrically independent Schottky and MOSFET pinout for design flexibility.





MOSFET Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	-3.3	Α
	- Pulsed	Ī	-20	-C C0
P <sub>D</sub>	Power Dissipation for Dual Operation		2	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1	
	127 July 200	(Note 1c)	0.9	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Rang	je	-55 to +150	°C

## Schottky Diode Maximum Ratings TA=25°C unless otherwise noted

V <sub>RRM</sub>	Repetitive Peak Reverse Voltage		20	V
lo	Average Forward Current	(Note 1a)	1	Α

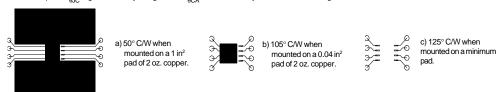
Package Marking and Ordering Information

	Device Marking Device		Reel Size	Tape Width	Quantity	
	FDFS2P102	FDFS2P102	13	12mm	2500 units	
DE						

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Symbol	Parameter	Test C	Min	Тур	Max	Units	
Off Char	acteristics	•		•	!		
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = - 16 V,				-1	μд
	_	$V_{GS} = 0 V$	$T_J = 55^{\circ}C$			-10	
$I_{GSSF}$	Gate-Body Forward Leakage	$V_{GS} = 20 \text{ V}, \text{ V}$	$I_{DS} = 0 \text{ V}$			100	nA
$I_{GSSR}$	Gate-Body Reverse Leakage	$V_{GS} = -20 V$ ,	$V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D}$	= -250 µA	-1	-1.4	-2	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V},$		0.100	0.125	Ω	
50(011)		$V_{GS} = -4.5 \text{ V},$		0.167	0.2	1	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -10 \text{ V}, ^{1}$		-10			Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}$	I <sub>D</sub> = -3.3 A		5		S
Dynamia	Charactaristics			•		•	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$			270		pF
Coss	Output Capacitance	f = 1.0 MHz		150		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	ł		45		pF	
		ļ					P.
SWITCHIN t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = -15 V,	In = -1 A.		8	16	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = -10 \text{ V},$		7	14	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	t		17	27	ns	
t <sub>f</sub> (oii)	Turn-Off Fall Time			10	1.8	ns	
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -3.3 A,		7	10	nC	
<b>Q</b> g	Total date onlinge	$V_{GS} = -3 \text{ V}, \text{ 1D} = -3.3 \text{ A},$ $V_{GS} = -10 \text{ V},$			,	10	110
Drain-So	ource Diode Characteristics ar	nd Maximur	m Ratings				
Is	Maximum Continuous Drain-Source D				-1.3	Α	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -1.3 \text{ A}$ (Note 2)			-0.8	-1.2	V
Sahattka	, Diada Characteristics			•	!		
<u>Schollky</u> I <sub>R</sub>	Note: Characteristics Reverse Leakage	V <sub>R</sub> = 20 V	$T_{J} = 25^{\circ}C$		ĺ	250	uA
'K	Thoronoo Louinago	VR-20 V	$T_{J} = 125^{\circ}C$			18	mA
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 1 A	$T_{.1} = 25^{\circ}C$			0.47	V
	_		$T_{J} = 125^{\circ}C$			0.39	
		I <sub>F</sub> = 2 A	$T_J = 25^{\circ}C$			0.58	
			$T_{J} = 125^{\circ}C$			0.53	
Thermal	Characteristics						
R <sub>JA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)				78		
R <sub>JC</sub>	Thermal Resistance, Junction-to-Case (Note 1)				40		

<sup>1:</sup>  $R_{BJA}$  is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{BJC}$  is guaranteed by design while  $R_{BCA}$  is determined by the user's board design.



Scale 1 : 1 on letter size paper

2: Pulse Test: Pulse Width  $\leq\!300\,\mu\text{s}$  , Duty Cycle  $\leq\!2.0\%$ 

# **Typical Characteristics**

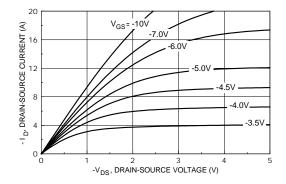


Figure 1. On-Region Characteristics.

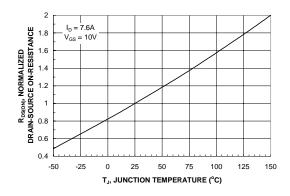


Figure 3. On-Resistance Variation with Temperature.

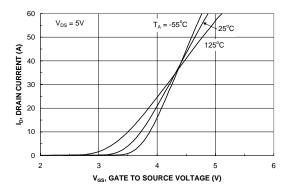


Figure 5. Transfer Characteristics.

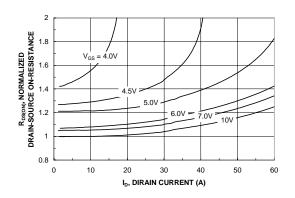


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

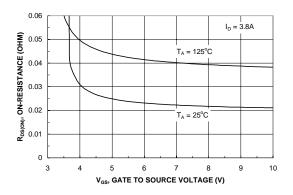


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

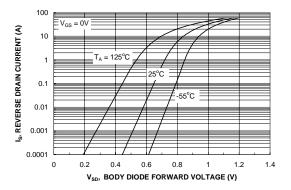
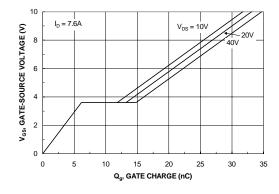


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

# Typical Characteristics (continued)



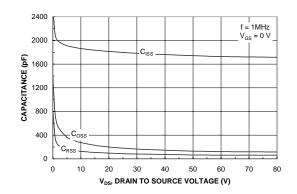
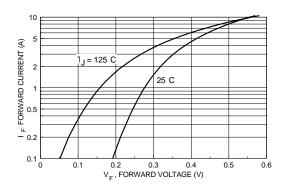


Figure 7. Gate-Charge Characteristics.





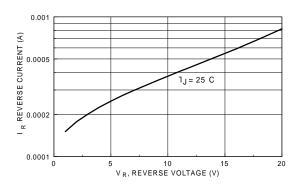


Figure 9. Schottky Diode Forward Voltage.

Figure 10. Schottky Diode Reverse Current.

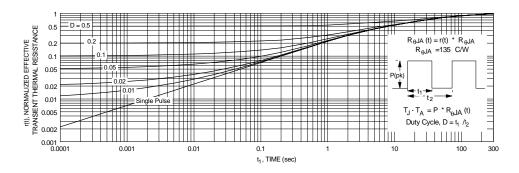


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient themal response will change depending on the circuit board design.

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